	ATO EST-MA	MARKET MARKET TO A STATE OF THE	10/12000	7.5
FORM PTO-1595 (modified)	07-22-2002	ER SHEE		
	1400 MA 1000 MA 1000 MA 100 MA 100 MA	1	Patent and Trademar 3 Rec'd PCT/PTO 0 1 MAY 200	
To the Honorable Assistant Secretary or copy(ies) thereof.	102163494		e record the attached original docume	
1. Name of conveying party(ies):	5-1-02	2. Name and addre	ess of receiving party(ies):	
Noriaki YOSHIDA; Osamu OKUDA; Akira KABESHITA; and Takeyuki KAWASE		Name: Matsushita Electric Industrial Co., Ltd.  Street Address: 1006, Oaza Kadoma, Kadoma-shi,		
Additional name(s) of conveying party(ies) attached? No		Street Address.	Osaka 571-8501 Japan	-
3. Nature of conveyance:				
X Assignment Merger Security Agreement Change of Name Other Execution Date: March 14 and March 18, 2002		Additional name(s) & address(es) attached? No		
4. Application number(s) or patent				-
If this document is being filed tog March 18, 2002		n, the execution date	e of the application is: March 14 a	and
A. Patent Application No.(s) 10,129 005		B. Patent No.(s) , issued		
	Additional numbers	s attached? <u>No</u>		
5. Name and address of party to whom correspondence concerning document should be mailed:		6. Total number of	applications and patents involved	d: <u>1</u>
Name: WENDEROTH, LIND & PONACK, L.L.P. Attn: Michael S. Huppert, Esq.		7. Total fee (37 CFR 3.41) \$40.00		
Street Address: 2033 K Street, N.W., Suite 800		X Enclosed (Check No. 50044 ) Authorized to be charged to deposit account		
City: Washington, State: DC ZIP: 20006-1021		8. Deposit account number: 23-0975		
	DO NOT USE T	·	py of this page if paying by deposit accou	int)
	DO NOT USE I	MIS SPACE		
original document.  Michael S. Huppert , Reg. No. 40,2	68 Muselion	is true and correct an	d any attached copy is a true copy of  May 1, 2002  Date	the
Name of Person Signing	Signature	Total nu	mber of pages including cover sho	eet: <u>3</u>
OMB No. 0651-0011 (exp. 4/94)				
Mail documents to be recorded with re	Do not detach of the property	TO CHAI FEES FC tary of Patents ChOH nments	MMISSIONER IS AUTHORIZED RGE ANY DEFICIENCY IN THE PRICE TO DEPOSIT	
Public burden reporting for this sample time for reviewing the document and goomments regarding this burden estimated washington, D.C. 20231, and the Off 20503.	cover sheet is estimated to av athering the data needed, and ate to the U.S. Patent and Trad	erage about 30 minute completing and review lemark Office, Office o	ring the sample cover sheet. Send of Information Systems, PK2-1000C,	

PATENT REEL: 013094 FRAME: 0438

## ASSIGNMENT

	In consideration of the sum of One Dollar (\$1.00) and other good and valuable consideration paid to each of the undersigned
	Noriaki YOSHIDA,
Insert Name(s)	Osamu OKUDA,
of Inventor(s)	Akira KABESHITA, and
	Takeyuki KAWASE
•	
,	the undersigned hereby sell(s) and assign(s) to
Insert Name(s) of Assignee(s)	Matsushita Electric Industrial Co., Ltd.
_	of 1006, Oaza Kadoma, Kadoma-shi, Osaka 571-8501 Japan
Address	(hereinafter designated as the Assignee) the entire right, title and interest for the United States as defined in 35 USC 100, in the invention known as
Title of Invention	COMPONENT MOUNTING APPARATUS AND METHOD
Date of Signing	for which an application for patent in the United States has been executed by the undersigned on
of Application	March 18, March 14, March 14, and March 14, 2002,
	respectively.

The undersigned agree(s) to execute all papers necessary in connection with this application and any continuing, divisional or reissue applications thereof and also to execute separate assignments in connection with such applications as the Assignee may deem necessary or expedient.

The undersigned agree(s) to execute all papers necessary in connection with any interference which may be declared concerning this application or continuation, division or reissue thereof and to cooperate with the Assignee in every way possible in obtaining evidence and going forward with such interference.

The undersigned agree(s) to execute all papers and documents and perform any act which may be necessary in connection with claims or provisions of the International Convention for Protection of Industrial Property or similar agreements.

The undersigned agree(s) to perform all affirmative acts which may be necessary to obtain a grant of a valid United States patent to the Assignee.

The undersigned hereby authorize(s) and request(s) the Commissioner of Patents to issue any and all Letters Patents of the United States resulting from said application or any division or divisions or continuing or reissue applications thereof to the said Assignee, as Assignee of the entire interest, and hereby covenants that he has (they have) full right to convey the entire interest herein assigned, and that he has (they have) not executed, and will not execute, any agreement in conflict herewith.

PATENT REEL: 013094 FRAME: 0439 The undersigned hereby grant(s) the firm of WENDEROTH, LIND & PONACK, L.L.P., 2033 K Street, N.W., Suite 800, Washington, DC 20006, the power to insert on this assignment any further identification which may be necessary or desirable in order to comply with the rules of the United States Patent Office for recordation of this document.

In witness whereof, executed by the undersigned on the date(s) opposite the undersigned name(s). Date 19 3 2002, Name of Inventor Noriaki YOSHIDA Date 14, 3. 202, Name of Inventor Osamu OKUDA Osamu Okula Date 14 3. 2002, Name of Inventor Akira KABESHI Date 14 3 2002, Name of Inventor Takeyuki KAWA Date \_\_\_\_\_, Name of Inventor \_\_\_\_\_ Date \_\_\_\_\_\_, Name of Inventor \_\_\_\_\_\_ (This assignment should preferably be acknowledged before a United States Consul. If not, then the execution by the Inventor(s) should be witnessed by at least two witnesses who sign here.) Witness Jasunen Ja \_\_\_\_\_ ACKNOWLEDGEMENT This \_\_\_\_\_\_, day of \_\_\_\_\_\_, before me personally came the above-named\_\_\_\_\_\_ to me personally known as the individual(s) who executed the foregoing assignment, who did acknowledge to me that he (they) executed the same of his (their) own free will for the purposes therein set forth. Official Signature SEAL Official Title The above application may be more particularly identified as follows: U.S. Application Serial No. \_\_\_\_\_\_Filing Date 5/01/02 Applicant Reference Number 535600 Atty Docket No. 2002 - 05919 Title of Invention COMPONENT MOUNTING APPARATUS AND METHOD

RECORDED: 05/01/2002

PATENT REEL: 013094 FRAME: 0440